



N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

Device	BV _{DSS}	R _{DS(ON)} Max	I _D Max T _C = +25°C (Note 10)
		$11.1 \text{m}\Omega$ @ $V_{GS} = 10V$	30A
Q1 & Q2	30V	13.8mΩ @ V _{GS} = 4.5V	28A
		22.0mΩ @ V_{GS} = 3.8 V	22A

Features and Benefits

- Low Gate Threshold Voltage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen- and Antimony-Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

Description

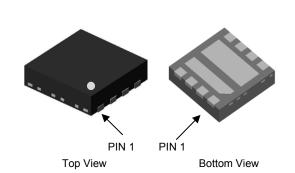
This new generation MOSFET is designed to minimize the on-state resistance ($R_{DS(ON)}$), yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

Applications

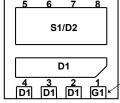
- General Purpose Interfacing Switch
- Power Management Functions

Mechanical Data

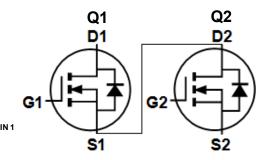
- Case: V-DFN3030-8 (Type K)
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper Lead-Frame.
 Solderable per MIL-STD-202, Method 208 @4
- Weight: 0.02 grams (Approximate)



V-DFN3030-8 (Type K)



Bottom View Internal Schematic



Equivalent Circuit

Ordering Information (Note 4)

Part Number	Case	Tape Width	Tape Pitch	Packaging
DMT3009LDT-7	V-DFN3030-8 (Type K)	8mm	4mm	3,000/Tape & Reel
DMT3009LDT-7A	V-DFN3030-8 (Type K)	12mm	8mm	1,500/Tape & Reel

Notes:

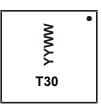
- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See http://www.diodes.com/quality/lead_free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



Marking Information

Site 1

V-DFN3030-8 (Type K)



T30= Product Type Marking Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 20 = 2020) WW = Week Code (01 to 53)

Site 2

** X X T30

T30= Product Type Marking Code YWX = Date Code Marking Y = Year (ex: 0= 2020) W = Week (ex: a = week 27; z represents week 52 and 53) X = Internal code (ex: U = Monday)

Date Code Key

Year	2020	2021	2022	2023	2024	4 2025	2026	2027	
Code	0	1	2	3	4	5	6	7	
Week	1-26			27-52			53		
Code	A-Z			a-z			z		
Internal Code	Sun	Mon	-	Tue	Wed	Thu	Fri	Sat	
Code	Т	11		V	۱۸/	Y		7	

Maximum Ratings (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Q1&Q2	Unit		
Drain-Source Voltage	V_{DSS}	30	V		
Gate-Source Voltage	V_{GSS}	+20, -16	V		
Continuous Drain Current (Note 6) V _{GS} = 10V	Steady State (Note 10)	T_C = +25°C T_C = +70°C	I _D	30 25	Α
Continuous Diam Current (Note 6) V _{GS} = 10V	t<10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	14 11	Α
Maximum Body Diode Forward Current (Note 6)	I _S	2.1	Α		
Pulsed Drain Current (100µs Pulse, Duty Cycle = 1%)	I _{DM}	80	Α		
Pulsed Body Diode Forward Current (370µs Pulse, Duty (I _{SM}	80	Α		
Avalanche Current (Note 7) L = 0.1mH	I _{AS}	19.3	Α		
Avalanche Energy (Note 7) L = 0.1mH	Eas	18.6	mJ		



Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	T _A = +25°C	6	1.2	W
Total Power Dissipation (Note 5)	T _A = +70°C	P_{D}	0.8	
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	D	107	°C/W
Thermal Resistance, Junction to Ambient (Note 3)	t<10s	$R_{\theta JA}$	63	
Total Power Dissipation (Note 6)	$T_A = +25^{\circ}C$	5	2.0	W
Total Fower Dissipation (Note 0)	$T_A = +70^{\circ}C$	P_{D}	1.2	
Thormal Posistance, Junction to Ambient (Note 6)	Steady State	Б	64	
Thermal Resistance, Junction to Ambient (Note 6)	t<10s	$R_{\theta JA}$	39	°C/W
Thermal Resistance, Junction to Case (Note 6)	$R_{ heta JC}$	7.6		
Operating and Storage Temperature Range		$T_{J_i} T_{STG}$	-55 to +150	°C

Electrical Characteristics (@ T_A = +25°C, unless otherwise specified.)

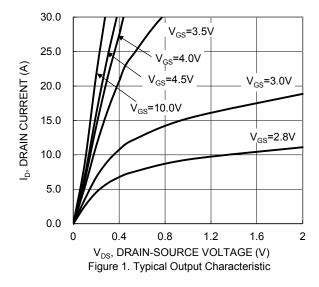
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)	1		1		T.	
Drain-Source Breakdown Voltage	BV _{DSS}	30		_	V	$V_{GS} = 0V, I_D = 250\mu A$
Zero Gate Voltage Drain Current	IDSS	_		1	μΑ	$V_{DS} = 24V, V_{GS} = 0V$
Zero Gate Voltage Drain Current T_J = +150°C (Note 9)	I _{DSS}		_	100	μΑ	V _{DS} = 24V, V _{GS} = 0V
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = 20V, V_{DS} = 0V$ $V_{GS} = -16V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	V _{GS(TH)}	1	_	3	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$
		_	7.2	11.1		$V_{GS} = 10V, I_D = 14.4A$
Static Drain-Source On-Resistance	R _{DS(ON)}	_	10.5	13.8	mΩ	$V_{GS} = 4.5V, I_D = 7A$
	, ,	_	13	22.0		V _{GS} = 3.8V, I _D = 5A
Diode Forward Voltage	V_{SD}	_	_	1.2	V	$V_{GS} = 0V, I_S = 10A$
DYNAMIC CHARACTERISTICS (Note 9)						
Input Capacitance	Ciss	_	748	1,500		V _{DS} = 15V, V _{GS} = 0V, f = 1.0MHz
Output Capacitance	Coss	_	447	895	pF	
Reverse Transfer Capacitance	Crss	_	43	90		
Gate Resistance	R_g	_	1.0	2.0	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$
Total Gate Charge (V _{GS} = 10V)	Q_g	_	13.8	20		
Total Gate Charge (V _{GS} = 4.5V)	Q_g	_	6.4	9	nC	V 45V L 44.4A
Gate-Source Charge	Q_{gs}	_	2.2	5	IIC	V _{DS} = 15V, I _D = 14.4A
Gate-Drain Charge	Q_{gd}	_	2.2	5		
Turn-On Delay Time	t _{D(ON)}	_	3.5	7		
Turn-On Rise Time	t _R		5.0	10	no	$V_{GS} = 10V, V_{DD} = 15V, R_g = 1\Omega,$
Turn-Off Delay Time	t _{D(OFF)}		8.6	17	ns	I _D = 10A
Turn-Off Fall Time	t _F		1.4	3		
Body Diode Reverse Recovery Time	t _{RR}	_	18	33	ns	I _F = 10A, di/dt = 100A/µs
Body Diode Reverse Recovery Charge	Q_{RR}		7.7	15	nC	I _F = 10A, di/dt = 100A/μs

Notes:

- 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
 6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1-inch square copper plate.
 7. UIS in production with L = 0.1mH, starting T_A = +25°C.

- Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to product testing.
- 10. Package limited.





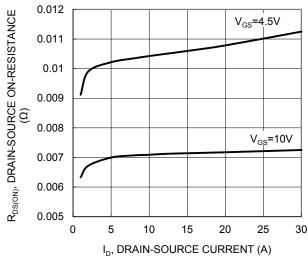


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

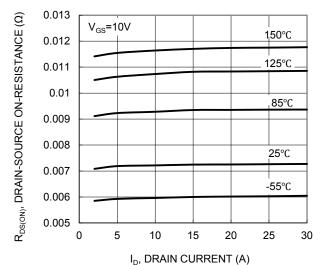
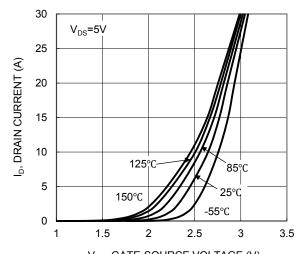


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature



V_{GS}, GATE-SOURCE VOLTAGE (V) Figure 2. Typical Transfer Characteristic

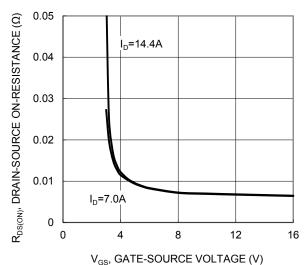


Figure 4. Typical Transfer Characteristic

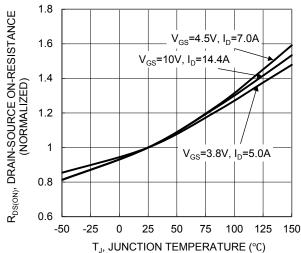


Figure 6. On-Resistance Variation with Junction Temperature



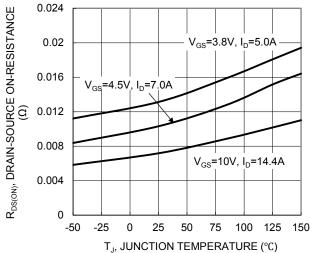


Figure 7. On-Resistance Variation with Junction
Temperature

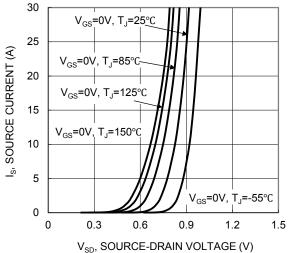
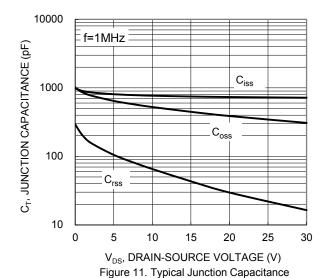


Figure 9. Diode Forward Voltage vs. Current



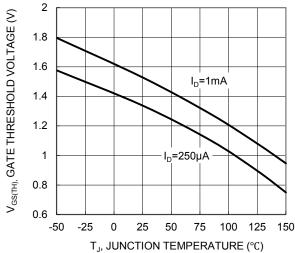


Figure 8. Gate Threshold Variation vs. Junction
Temperature

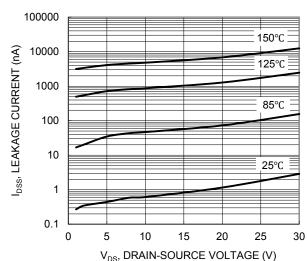
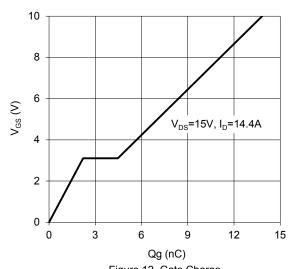


Figure 10. Typical Drain-Source Leakage Current vs. Voltage





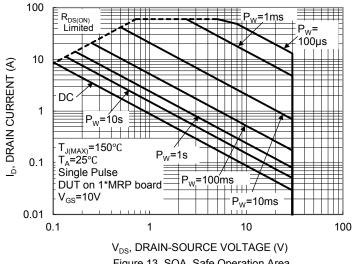


Figure 13. SOA, Safe Operation Area

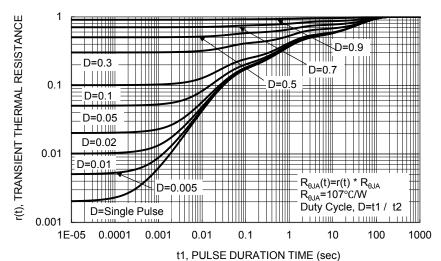


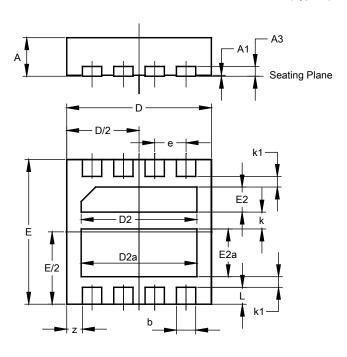
Figure 14. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

V-DFN3030-8 (Type K)

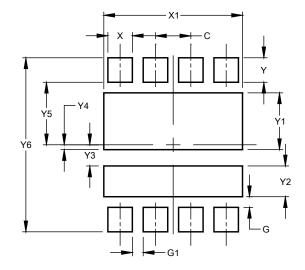


V-DFN3030-8							
(Type K)							
Dim	Min	Max	Тур				
Α	0.77	0.85	0.80				
A 1	0.00	0.05	0.02				
A 3	0	.20BSC					
b	0.35	0.45	0.40				
D	2.95	3.050	3.00				
D2	2.30	2.50	2.40				
D2a	2.30	2.50	2.40				
Е	2.95	3.050	3.00				
E2	0.42	0.62	0.52				
E2a	0.89	1.09	0.99				
е	0.65BSC						
k	-	1	0.35				
k1	-	-	0.22				
L	0.30	0.40	0.35				
Z	0.325BSC						
All Dimensions in mm							

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

V-DFN3030-8 (Type K)



Dimensions	Value		
	(in mm)		
С	0.650		
G	0.195		
G1	0.200		
X	0.450		
X1	2.550		
Y	0.450		
Y1	1.044		
Y2	0.566		
Y3	0.389		
Y4	0.089		
Y5	1.150		
Y6	3.200		



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